

KSC3073

Power Amplifier Application

Complement to KSA1243



NPN Epitaxial Silicon Transistor

Absolute Maximum Ratings $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	30	V
V_{CEO}	Collector-Emitter Voltage	30	V
V _{EBO}	Emitter-Base Voltage	5	V
I _C	Collector Current	3	Α
I _B	Base Current	0.6	Α
P _C	Collector Dissipation (T _a =25°C)	1	W
	Collector Dissipation (T _C =25°C)	15	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 55 ~ 150	°C

Electrical Characteristics $T_C=25$ °C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10 \text{mA}, I_B = 0$	30			V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = 1 \text{mA}, I_C = 0$	5			V
I _{CBO}	Collector Cut-off Current	$V_{CB} = 20V, I_{E} = 0$			1	μΑ
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 5V, I_{C} = 0$			1	μΑ
h _{FE1}	DC Current Gain	$V_{CE} = 2V, I_{C} = 0.5A$	70		240	
h_{FE2}		$V_{CE} = 2V, I_{C} = 2.5A$	25			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_C = 2A, I_B = 0.2A$		0.3	0.8	V
V _{BE} (on)	Base-Emitter On Voltage	$V_{CE} = 2V, I_{C} = 0.5A$		0.75	1	V
f _T	Current Gain Bandwidth Product	$V_{CE} = 2V, I_{C} = 0.5A$		100		MHz
C _{ob}	Output Capacitance	V _{CB} = 10V, f =1MHz		35		pF

h_{FE} Classification

Classification	0	Υ	
h _{FE1}	70 ~ 140	120 ~ 240	

Typical Characteristics

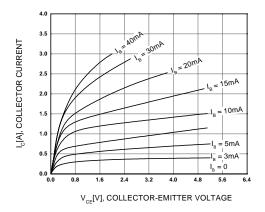


Figure 1. Static Characteristic

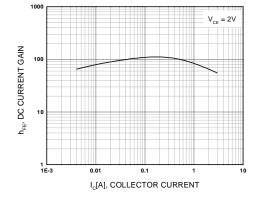


Figure 2. DC current Gain

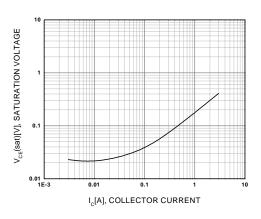


Figure 3. Collector-Emitter Saturation Voltage

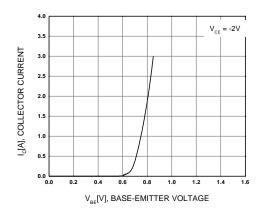


Figure 4. Base-Emitter on Voltage

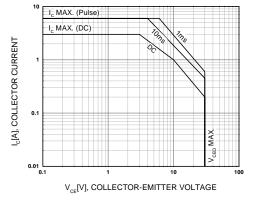


Figure 5. Safe Operating Area

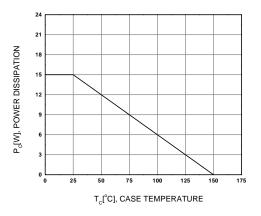
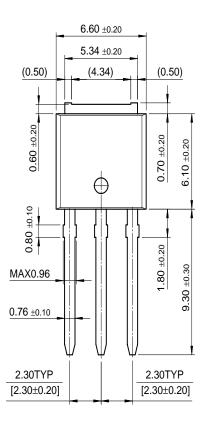


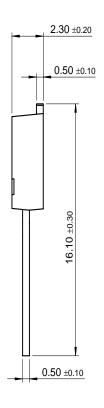
Figure 6. Power Derating

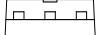
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Package Dimensions

I-PAK







Dimensions in Millimeters

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Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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